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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

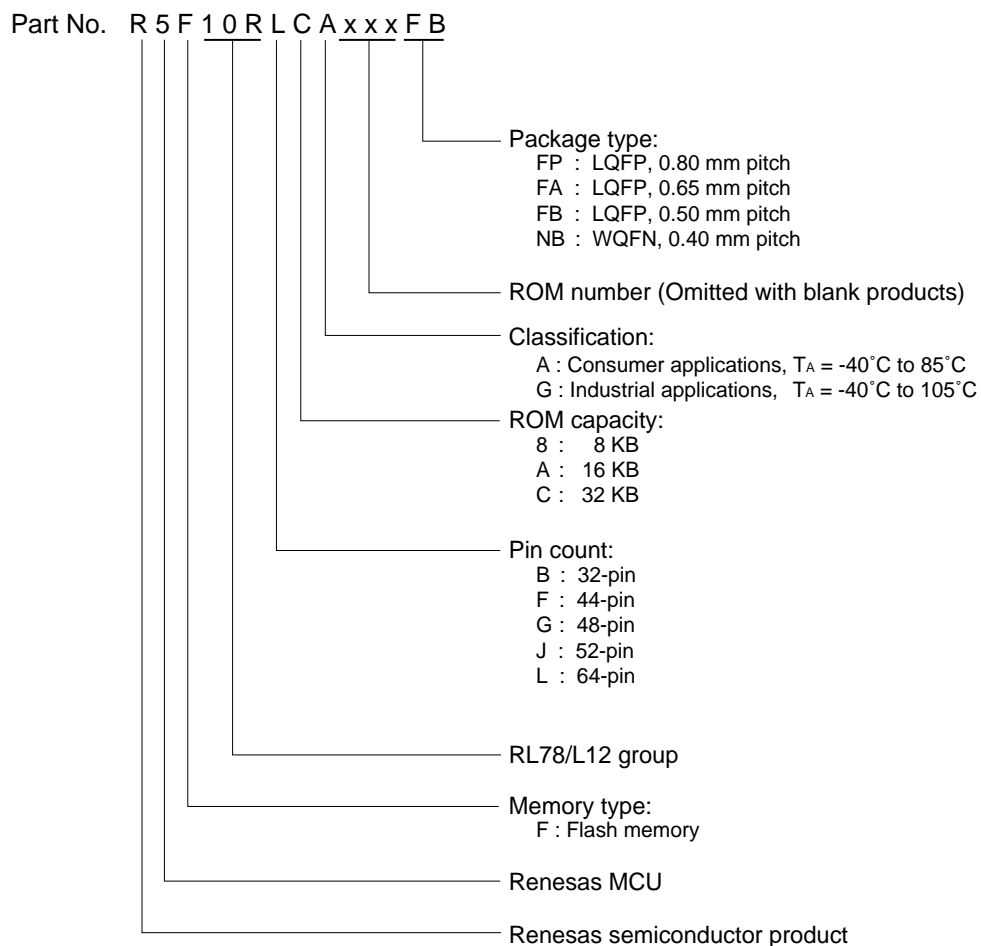
### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	RL78
Core Size	16-Bit
Speed	24MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LCD, LVD, POR, PWM, WDT
Number of I/O	47
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f10rlcafb-x0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f10rlcafb-x0</a>

## 1.2 List of Part Numbers

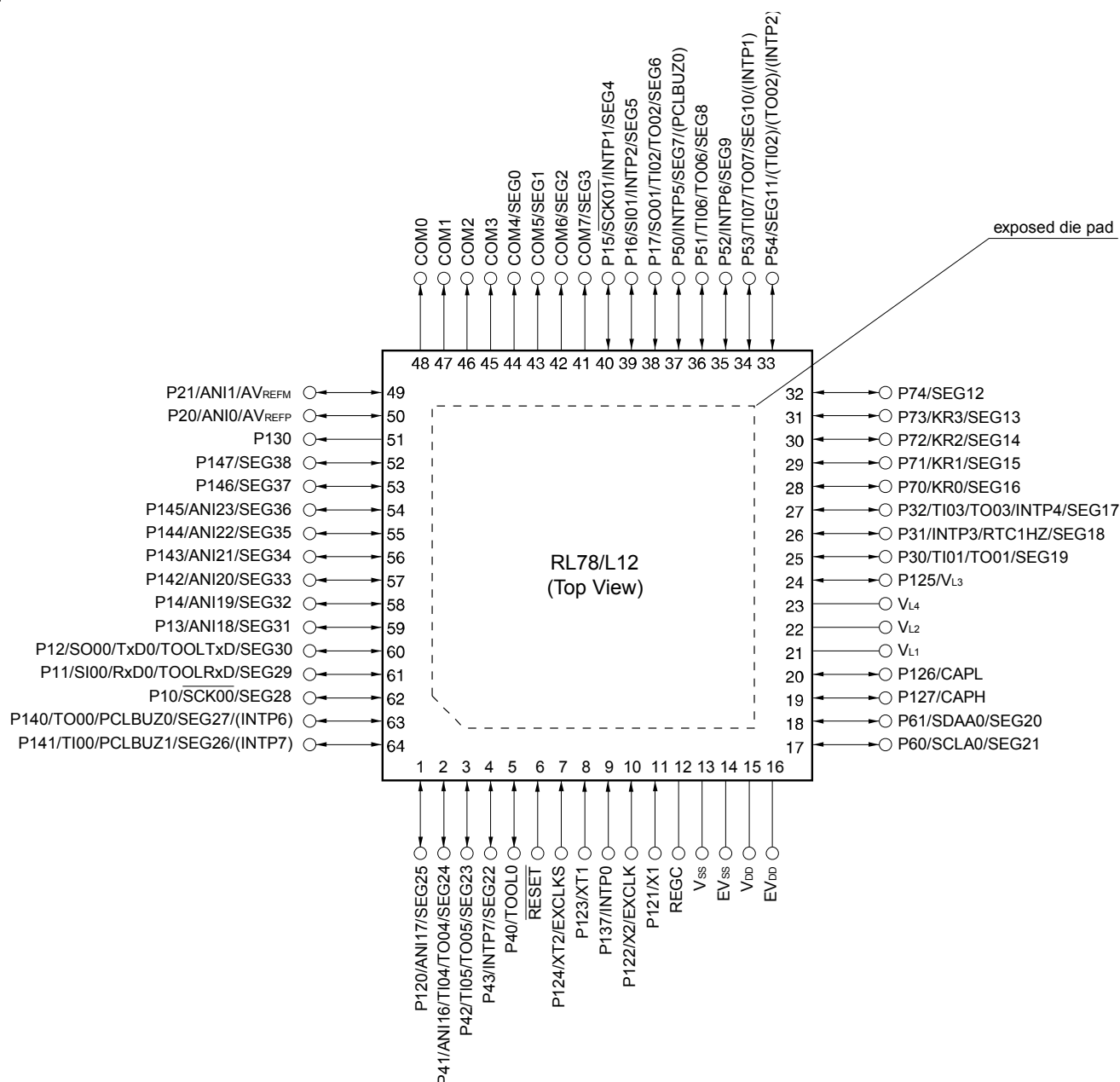
Figure 1-1 Part Number, Memory Size, and Package of RL78/L12



## 1.3.5 64-pin products

- 64-pin plastic WQFN (8 × 8)

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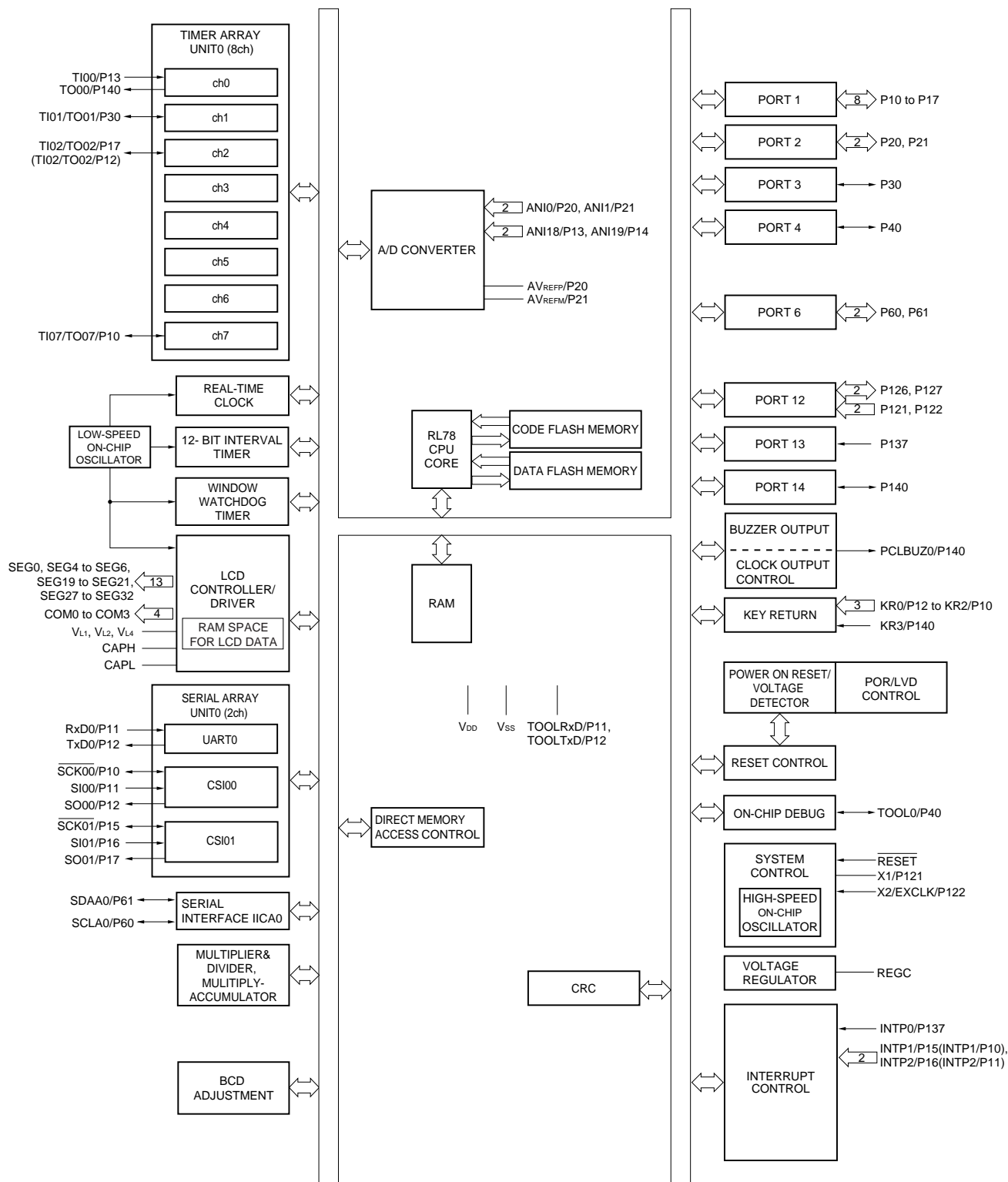


- Cautions**
1. Make EV<sub>ss</sub> pin the same potential as V<sub>ss</sub> pin.
  2. Make V<sub>DD</sub> pin the same potential as EV<sub>DD</sub> pin.
  3. Connect the REGC pin to V<sub>ss</sub> via a capacitor (0.47 to 1  $\mu$ F).

- Remarks**
1. For pin identification, see 1.4 Pin Identification.
  2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the V<sub>DD</sub> and EV<sub>DD</sub> pins and connect the V<sub>ss</sub> and EV<sub>ss</sub> pins to separate ground lines.
  3. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR).

## 1.5 Block Diagram

### 1.5.1 32-pin products



**Remark** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR)

(2/2)

Item		32-pin	44-pin	48-pin	52-pin	64-pin
		R5F10RBx	R5F10RFx	R5F10RGx	R5F10RJx	R5F10RLx
Timer	16-bit timer	8 channels	8 channels (with 1 channel remote control output function)			
	Watchdog timer	1 channel				
	Real-time clock (RTC)	1 channel				
	12-bit interval timer (IT)	1 channel				
	Timer output	4 channels (PWM outputs: 3 <sup>Note 1</sup> )	5 channels (PWM outputs: 4 <sup>Note 1</sup> )	6 channels (PWM outputs: 5 <sup>Note 1</sup> )	8 channels (PWM outputs: 7 <sup>Note 1</sup> )	
	RTC output	–	1 • 1 Hz (subsystem clock: f <sub>SUB</sub> = 32.768 kHz or )			
Clock output/buzzer output		1	2			
		• 2.44 kHz, 4.88 kHz, 9.76 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (Main system clock: f <sub>MAIN</sub> = 20 MHz operation) • 256 Hz, 512 Hz, 1.024 kHz, 2.048 kHz, 4.096 kHz, 8.192 kHz, 16.384 kHz, 32.768 kHz (Subsystem clock: f <sub>SUB</sub> = 32.768 kHz operation)				
8/10-bit resolution A/D converter		4 channels	7 channels	9 channels	10 channels	10 channels
Serial interface		• CSI: 2 channel/UART (LIN-bus supported): 1 channel				
	I <sup>2</sup> C bus	1 channel	1 channel	1 channel	1 channel	1 channel
Multiplier and divider/multiply-accumulator		• 16 bits × 16 bits = 32 bits (Unsigned or signed) • 32 bits ÷ 32 bits = 32 bits (Unsigned) • 16 bits × 16 bits + 32 bits = 32 bits (Unsigned or signed)				
DMA controller		2 channels				
Vectored interrupt sources	Internal	23	23	23	23	23
	External	4	6	7	7	9
Key interrupt		4				
Reset		• Reset by $\overline{\text{RESET}}$ pin • Internal reset by watchdog timer • Internal reset by power-on-reset • Internal reset by voltage detector • Internal reset by illegal instruction execution <sup>Note 2</sup> • Internal reset by RAM parity error • Internal reset by illegal-memory access				
Power-on-reset circuit		• Power-on-reset: 1.51 ±0.04 V • Power-down-reset: 1.50 ±0.04 V				
Voltage detector		• Rising edge : 1.67 V to 4.06 V (14 stages) • Falling edge : 1.63 V to 3.98 V (14 stages)				
On-chip debug function		Provided				
Power supply voltage		V <sub>DD</sub> = 1.6 to 5.5 V				
Operating ambient temperature		T <sub>A</sub> = –40 to +85 °C				

**Notes** 1. The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves).

2. The illegal instruction is generated when instruction code FFH is executed.

Reset by the illegal instruction execution not issued by emulation with the in-circuit emulator or on-chip debug emulator.

## 2.3 DC Characteristics

## 2.3.1 Pin characteristics

(T<sub>A</sub> = -40 to +85°C, 1.6 V ≤ EV<sub>DD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS</sub> = 0 V)

(1/5)

Items	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Output current, high <sup>Note 1</sup>	I <sub>OH1</sub>	Per pin for P10 to P17, P30 to P32, P40 to P43, P50 to P54, P70 to P74, P120, P125 to P127, P130, P140 to P147				-10.0 Note 2	mA
		Total of P10 to P14, P40 to P43, P120, P130, P140 to P147 (When duty = 70% <sup>Note 3</sup> )	4.0 V ≤ EV <sub>DD</sub> ≤ 5.5 V			-40.0	mA
			2.7 V ≤ EV <sub>DD</sub> < 4.0 V			-8.0	mA
			1.8 V ≤ EV <sub>DD</sub> < 2.7 V			-4.0	mA
			1.6 V ≤ EV <sub>DD</sub> < 1.8 V			-2.0	mA
		Total of P15 to P17, P30 to P32, P50 to P54, P70 to P74, P125 to P127 (When duty = 70% <sup>Note 3</sup> )	4.0 V ≤ EV <sub>DD</sub> ≤ 5.5 V			-60.0	mA
			2.7 V ≤ EV <sub>DD</sub> < 4.0 V			-15.0	mA
			1.8 V ≤ EV <sub>DD</sub> < 2.7 V			-8.0	mA
			1.6 V ≤ EV <sub>DD</sub> < 1.8 V			-4.0	mA
		Total of all pins (When duty = 70% <sup>Note 3</sup> )				-100.0	mA
	I <sub>OH2</sub>	P20, P21	Per pin			-0.1	mA
		Total of all pins		1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V		-0.2	mA

**Notes** 1. Value of current at which the device operation is guaranteed even if the current flows from the V<sub>DD</sub> and EV<sub>DD</sub> pins to an output pin.

2. Do not exceed the total current value.

3. Specification under conditions where the duty factor ≤ 70%.

The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins = (I<sub>OH</sub> × 0.7)/(n × 0.01)

<Example> Where n = 80% and I<sub>OH</sub> = -40.0 mA

$$\text{Total output current of pins} = (-40.0 \times 0.7)/(80 \times 0.01) \cong -35.0 \text{ mA}$$

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

**Caution** P10, P12, P15, and P17 do not output high level in N-ch open-drain mode.

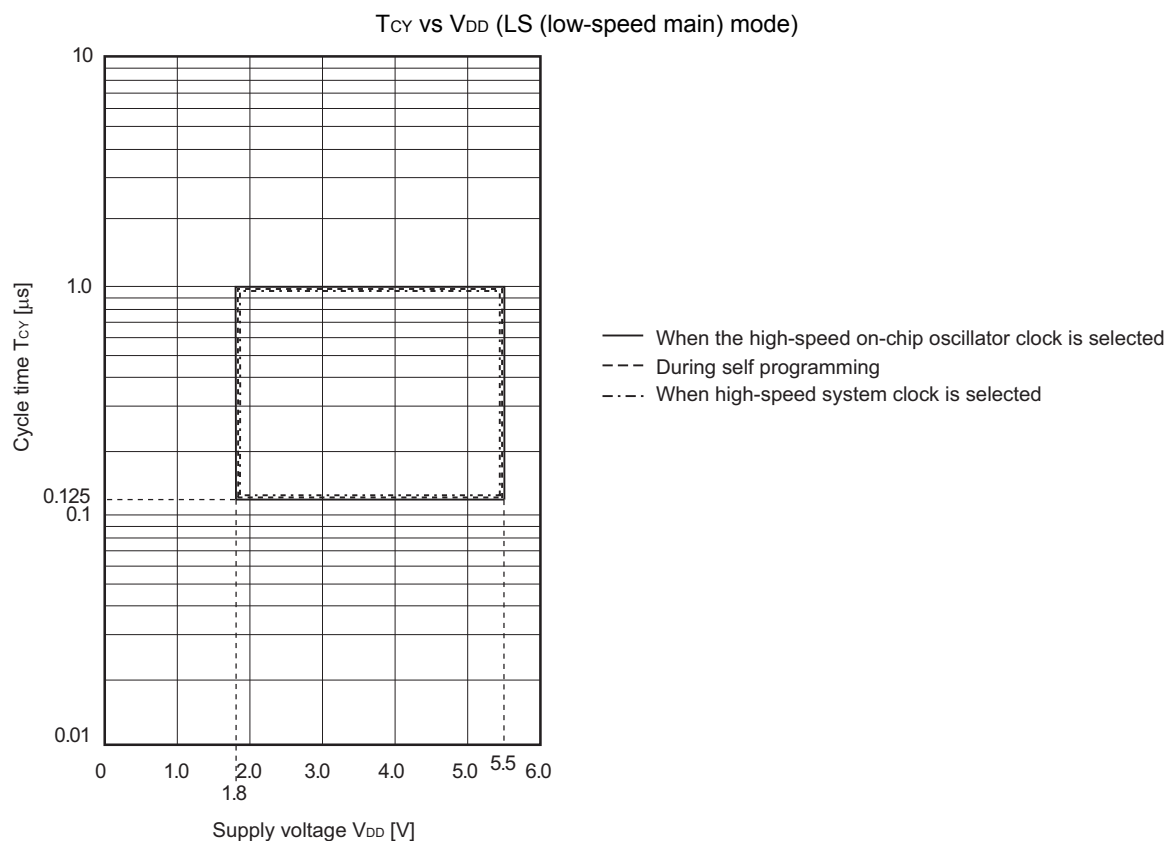
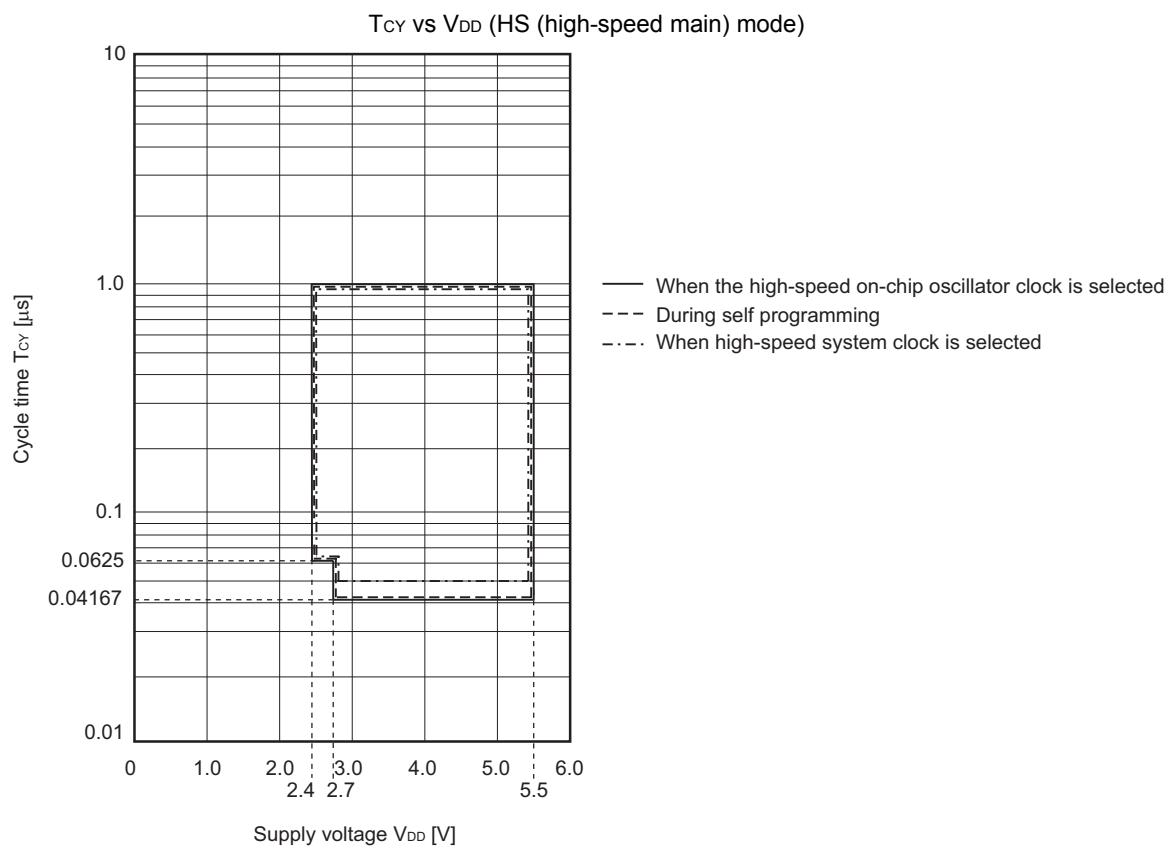
**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

(T<sub>A</sub> = -40 to +85°C, 1.6 V ≤ E<sub>VDD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = E<sub>VSS</sub> = 0 V)

(3/3)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Low-speed on-chip oscillator operating current	I <sub>FIL</sub> <sup>Note 1</sup>				0.20		μA
RTC operating current	I <sub>RTC</sub> <sup>Notes 1, 2, 3</sup>	f <sub>MAIN</sub> is stopped			0.08		μA
12-bit interval timer current	I <sub>IT</sub> <sup>Notes 1, 2, 4</sup>				0.08		μA
Watchdog timer operating current	I <sub>WDT</sub> <sup>Notes 1, 2, 5</sup>	f <sub>IL</sub> = 15 kHz			0.24		μA
A/D converter operating current	I <sub>ADC</sub> <sup>Notes 1, 6</sup>	When conversion at maximum speed	Normal mode, AV <sub>REFP</sub> = V <sub>DD</sub> = 5.0 V		1.3	1.7	mA
			Low voltage mode, AV <sub>REFP</sub> = V <sub>DD</sub> = 3.0 V		0.5	0.7	mA
A/D converter reference voltage current	I <sub>ADREF</sub> <sup>Note 1</sup>				75.0		μA
Temperature sensor operating current	I <sub>TMPS</sub> <sup>Note 1</sup>				75.0		μA
LVD operating current	I <sub>LVD</sub> <sup>Notes 1, 7</sup>				0.08		μA
Self-programming operating current	I <sub>FSP</sub> <sup>Notes 1, 9</sup>				2.50	12.20	mA
BGO operating current	I <sub>BGO</sub> <sup>Notes 1, 8</sup>				2.00	12.20	mA
LCD operating current	I <sub>LCD1</sub> <sup>Notes 11, 12</sup>	External resistance division method	V <sub>DD</sub> = E <sub>VDD</sub> = 5.0 V V <sub>L4</sub> = 5.0 V		0.04	0.20	μA
	I <sub>LCD2</sub> <sup>Note 11</sup>	Internal voltage boosting method	V <sub>DD</sub> = E <sub>VDD</sub> = 5.0 V V <sub>L4</sub> = 5.1 V (VLCD = 12H)		1.12	3.70	μA
			V <sub>DD</sub> = E <sub>VDD</sub> = 3.0 V V <sub>L4</sub> = 3.0 V (VLCD = 04H)		0.63	2.20	μA
	I <sub>LCD3</sub> <sup>Note 11</sup>	Capacitor split method	V <sub>DD</sub> = E <sub>VDD</sub> = 3.0 V V <sub>L4</sub> = 3.0 V		0.12	0.50	μA
SNOOZE operating current	I <sub>SNOZ</sub> <sup>Note 1</sup>	ADC operation	The mode is performed <sup>Note 10</sup>		0.50	0.60	mA
			The A/D conversion operations are performed, Low voltage mode, AV <sub>REFP</sub> = V <sub>DD</sub> = 3.0 V		1.20	1.44	mA
		CSI/UART operation			0.70	0.84	mA

(Notes and Remarks are listed on the next page.)

**Minimum Instruction Execution Time during Main System Clock Operation**



(2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output)  
(T<sub>A</sub> = -40 to +85°C, 1.6 V ≤ EV<sub>DD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS</sub> = 0 V)

Parameter	Symbol	Conditions	HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time	t <sub>KCY1</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V	167 Note 1		500 Note 1		1000 Note 1		ns
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V	250 Note 1		500 Note 1		1000 Note 1		ns
		1.8 V ≤ EV <sub>DD</sub> ≤ 5.5 V			500 Note 1		1000 Note 1		ns
		1.6 V ≤ EV <sub>DD</sub> ≤ 5.5 V					1000 Note 1		ns
SCKp high-/low-level width	t <sub>KH1</sub> , t <sub>KL1</sub>	4.0 V ≤ EV <sub>DD</sub> ≤ 5.5 V	t <sub>KCY1</sub> /2 - 12		t <sub>KCY1</sub> /2 - 50		t <sub>KCY1</sub> /2 - 50		ns
		2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V	t <sub>KCY1</sub> /2 - 18		t <sub>KCY1</sub> /2 - 50		t <sub>KCY1</sub> /2 - 50		ns
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V	t <sub>KCY1</sub> /2 - 38		t <sub>KCY1</sub> /2 - 50		t <sub>KCY1</sub> /2 - 50		ns
		1.8 V ≤ EV <sub>DD</sub> ≤ 5.5 V			t <sub>KCY1</sub> /2 - 50		t <sub>KCY1</sub> /2 - 50		ns
		1.6 V ≤ EV <sub>DD</sub> ≤ 5.5 V					t <sub>KCY1</sub> /2 - 100		ns
Slp setup time (to SCKp↑) Note 2	t <sub>SIK1</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V	44		110		110		ns
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V	75		110		110		ns
		1.8 V ≤ EV <sub>DD</sub> ≤ 5.5 V			110		110		ns
		1.6 V ≤ EV <sub>DD</sub> ≤ 5.5 V					220		ns
Slp hold time (from SCKp↑) Note 3	t <sub>KSH1</sub>	2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V	19		19		19		ns
		1.8 V ≤ EV <sub>DD</sub> ≤ 5.5 V			19		19		
		1.6 V ≤ EV <sub>DD</sub> ≤ 5.5 V					19		
Delay time from SCKp↓ to SOp output Note 4	t <sub>KSO1</sub>	C = 30 pF Note 5	2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V	25		25		25	ns
			1.8 V ≤ EV <sub>DD</sub> ≤ 5.5 V			25		25	
			1.6 V ≤ EV <sub>DD</sub> ≤ 5.5 V					25	

**Notes** 1. For CSI00, set a cycle of 2/f<sub>MCK</sub> or longer. For CSI01, set a cycle of 4/f<sub>MCK</sub> or longer.

2. When DAP<sub>mn</sub> = 0 and CKP<sub>mn</sub> = 0, or DAP<sub>mn</sub> = 1 and CKP<sub>mn</sub> = 1. The Slp setup time becomes “to SCKp↓” when DAP<sub>mn</sub> = 0 and CKP<sub>mn</sub> = 1, or DAP<sub>mn</sub> = 1 and CKP<sub>mn</sub> = 0.

3. When DAP<sub>mn</sub> = 0 and CKP<sub>mn</sub> = 0, or DAP<sub>mn</sub> = 1 and CKP<sub>mn</sub> = 1. The Slp hold time becomes “from SCKp↓” when DAP<sub>mn</sub> = 0 and CKP<sub>mn</sub> = 1, or DAP<sub>mn</sub> = 1 and CKP<sub>mn</sub> = 0.

4. When DAP<sub>mn</sub> = 0 and CKP<sub>mn</sub> = 0, or DAP<sub>mn</sub> = 1 and CKP<sub>mn</sub> = 1. The delay time to SOp output becomes “from SCKp↑” when DAP<sub>mn</sub> = 0 and CKP<sub>mn</sub> = 1, or DAP<sub>mn</sub> = 1 and CKP<sub>mn</sub> = 0.

5. C is the load capacitance of the SCKp and SOp output lines.

**Caution** Select the normal input buffer for the Slp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).

(Remarks are listed on the next page.)

## (4) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode)

(2/2)

(T<sub>A</sub> = -40 to +85°C, 1.8 V ≤ EV<sub>DD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS</sub> = 0 V)

Parameter	Symbol	Conditions	HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Transfer rate		Transmission	4.0 V ≤ EV <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V			Note 1		Note 1	bps
			Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 1.4 kΩ, V <sub>b</sub> = 2.7 V			2.8 <sup>Note 2</sup>		2.8 <sup>Note 2</sup>	Mbps
			2.7 V ≤ EV <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V			Note 3		Note 3	bps
			Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ, V <sub>b</sub> = 2.3 V			1.2 <sup>Note 4</sup>		1.2 <sup>Note 4</sup>	Mbps
			2.4 V ≤ EV <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V			Note 6		Note 6	bps
			Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 5.5 kΩ, V <sub>b</sub> = 1.6 V			0.43 <sup>Note 7</sup>		0.43 <sup>Note 7</sup>	Mbps
			1.8 V ≤ EV <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V				Notes 5, 6	Notes 5, 6	bps
			Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 5.5 kΩ, V <sub>b</sub> = 1.6 V				0.43 <sup>Note 7</sup>	0.43 <sup>Note 7</sup>	Mbps

**Notes 1.** The smaller maximum transfer rate derived by using f<sub>MCK</sub>/6 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 4.0 V ≤ EV<sub>DD</sub> ≤ 5.5 V and 2.7 V ≤ V<sub>b</sub> ≤ 4.0 V

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{2.2}{V_b})\} \times 3} \text{ [bps]}$$

$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{2.2}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

- 2.** This value as an example is calculated when the conditions described in the "Conditions" column are met. Refer to Note 1 above to calculate the maximum transfer rate under conditions of the customer.

3. The smaller maximum transfer rate derived by using  $f_{MCK}/6$  or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when  $2.7\text{ V} \leq E_{VDD} < 4.0\text{ V}$  and  $2.3\text{ V} \leq V_b \leq 2.7\text{ V}$

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\} \times 3} \text{ [bps]}$$

$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

4. This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 3 above to calculate the maximum transfer rate under conditions of the customer.
5. Use it with  $E_{VDD} \geq V_b$ .

6. The smaller maximum transfer rate derived by using  $f_{MCK}/6$  or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when  $1.8\text{ V} \leq E_{VDD} < 3.3\text{ V}$  and  $1.6\text{ V} \leq V_b \leq 2.0\text{ V}$

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{1.5}{V_b})\} \times 3} \text{ [bps]}$$

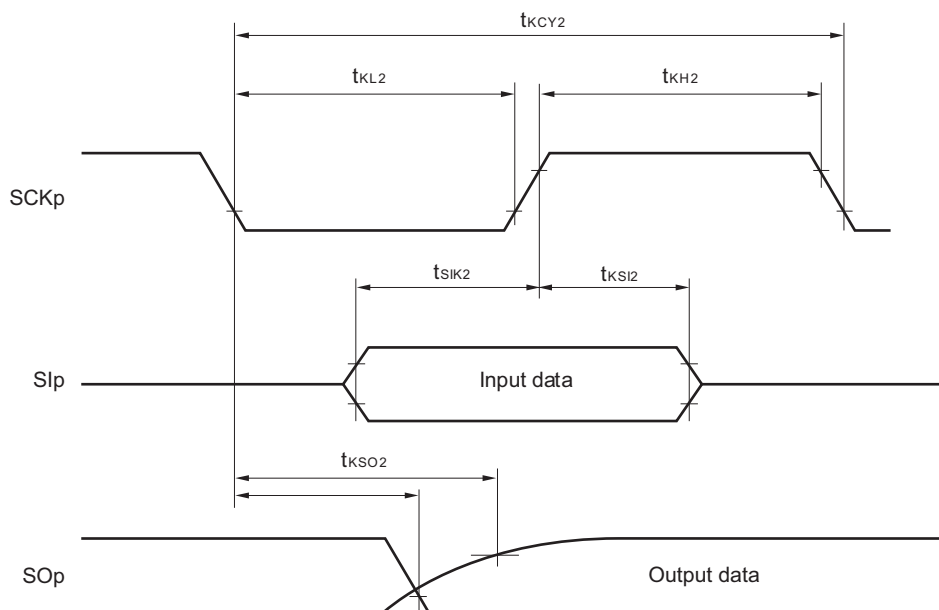
$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{1.5}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

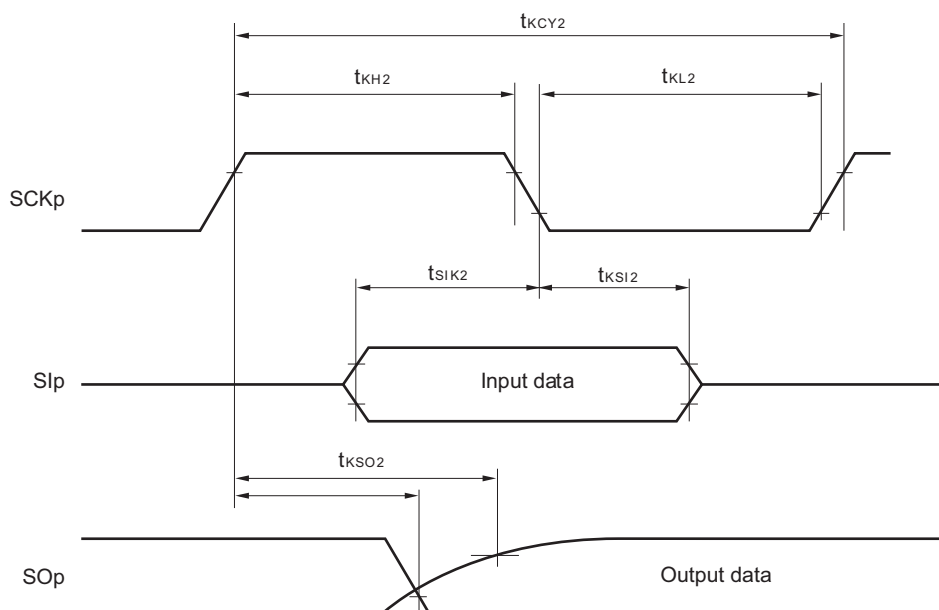
7. This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 6 above to calculate the maximum transfer rate under conditions of the customer.

**Caution** Select the TTL input buffer for the RxDq pin and the N-ch open drain output ( $V_{DD}$  tolerance (32-pin to 52-pin products)/ $E_{VDD}$  tolerance (64-pin products)) mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg). For  $V_{IH}$  and  $V_{IL}$ , see the DC characteristics with TTL input buffer selected.

**CSI mode serial transfer timing (slave mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)**



**CSI mode serial transfer timing (slave mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)**



**Remark** p: CSI number (p = 00, 01), m: Unit number (m = 0), n: Channel number (n = 0, 1),  
g: PIM and POM number (g = 1)

(4) When reference voltage (+) = Internal reference voltage (ADREFP1 = 1, ADREFP0 = 0), reference voltage (-) = AV<sub>REFM</sub>/ANI1 (ADREFM = 1), target pin : ANI0, ANI16 to ANI23

(T<sub>A</sub> = -40 to +85°C, 2.4 V ≤ EV<sub>DD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS</sub> = 0 V, Reference voltage (+) = V<sub>BGR</sub><sup>Note 3</sup>, Reference voltage (-) = AV<sub>REFM</sub><sup>Note 4</sup> = 0 V, HS (high-speed main) mode)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Resolution	RES			8			bit
Conversion time	t <sub>CONV</sub>	8-bit resolution	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V	17		39	μs
Zero-scale error <sup>Notes 1, 2</sup>	E <sub>ZS</sub>	8-bit resolution	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V			±0.60	%FSR
Integral linearity error <sup>Note 1</sup>	ILE	8-bit resolution	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V			±2.0	LSB
Differential linearity error <sup>Note 1</sup>	DLE	8-bit resolution	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V			±1.0	LSB
Analog input voltage	V <sub>AIN</sub>			0		V <sub>BGR</sub> <sup>Note 3</sup>	V

**Notes** 1. Excludes quantization error (±1/2 LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. Refer to **2.6.2 Temperature sensor/internal reference voltage characteristics**.

4. When reference voltage (-) = V<sub>SS</sub>, the MAX. values are as follows.

Zero-scale error: Add ±0.35%FSR to the MAX. value when reference voltage (-) = AV<sub>REFM</sub>.

Integral linearity error: Add ±0.5 LSB to the MAX. value when reference voltage (-) = AV<sub>REFM</sub>.

Differential linearity error: Add ±0.2 LSB to the MAX. value when reference voltage (-) = AV<sub>REFM</sub>.

## 2.6.2 Temperature sensor/internal reference voltage characteristics

(T<sub>A</sub> = -40 to +85°C, 2.4 V ≤ EV<sub>DD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS</sub> = 0 V) (HS (high-speed main) mode)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Temperature sensor output voltage	V <sub>TMPS25</sub>	Setting ADS register = 80H, T <sub>A</sub> = +25°C		1.05		V
Internal reference voltage	V <sub>BGR</sub>	Setting ADS register = 81H	1.38	1.45	1.5	V
Temperature coefficient	F <sub>VTMPS</sub>	Temperature sensor that depends on the temperature		-3.6		mV/°C
Operation stabilization wait time	t <sub>AMP</sub>		5			μs

(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ E<sub>VDD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = E<sub>VSS</sub> = 0 V)

(4/5)

Items	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output voltage, high	V <sub>OH1</sub>	P10 to P17, P30 to P32, P40 to P43, P50 to P54, P70 to P74, P120, P125 to P127, P130, P140 to P147	4.0 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OH1</sub> = -3.0 mA	E <sub>VDD</sub> - 0.7		V
			2.7 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OH1</sub> = -2.0 mA	E <sub>VDD</sub> - 0.6		V
			2.4 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OH1</sub> = -1.5 mA	E <sub>VDD</sub> - 0.5		V
	V <sub>OH2</sub>	P20, P21	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V, I <sub>OH2</sub> = -100 μA	V <sub>DD</sub> - 0.5		V
Output voltage, low	V <sub>OL1</sub>	P10 to P17, P30 to P32, P40 to P43, P50 to P54, P70 to P74, P120, P125 to P127, P130, P140 to P147	4.0 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OL1</sub> = 8.5 mA		0.7	V
			2.7 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OL1</sub> = 3.0 mA		0.6	V
			2.7 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OL1</sub> = 1.5 mA		0.4	V
			2.4 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OL1</sub> = 0.6 mA		0.4	V
	V <sub>OL2</sub>	P20, P21	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V, I <sub>OL2</sub> = 400 μA		0.4	V
	V <sub>OL3</sub>	P60, P61	4.0 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OL3</sub> = 15.0 mA		2.0	V
			4.0 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OL3</sub> = 5.0 mA		0.4	V
			2.7 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OL3</sub> = 3.0 mA		0.4	V
			2.4 V ≤ E <sub>VDD</sub> ≤ 5.5 V, I <sub>OL3</sub> = 2.0 mA		0.4	V

**Caution** P10, P12, P15, and P17 do not output high level in N-ch open-drain mode.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

**(4) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (1/2)****(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ EV<sub>DD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)**

Parameter	Symbol	Conditions		HS (high-speed main) Mode		Unit
				MIN.	MAX.	
Transfer rate		Reception	4.0 V ≤ EV <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V		f <sub>MCK</sub> /12 <sup>Note 1</sup>	bps
				Theoretical value of the maximum transfer rate f <sub>MCK</sub> = f <sub>CLK</sub> <sup>Note 2</sup>	2.0	Mbps
			2.7 V ≤ EV <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V		f <sub>MCK</sub> /12 <sup>Note 1</sup>	bps
				Theoretical value of the maximum transfer rate f <sub>MCK</sub> = f <sub>CLK</sub> <sup>Note 2</sup>	2.0	Mbps
			2.4 V ≤ EV <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V		f <sub>MCK</sub> /12 <sup>Note 1</sup>	bps
				Theoretical value of the maximum transfer rate f <sub>MCK</sub> = f <sub>CLK</sub> <sup>Note 2</sup>	2.0	Mbps

**Notes 1.** Transfer rate in the SNOOZE mode is 4800 bps only.**2.** The maximum operating frequencies of the CPU/peripheral hardware clock (f<sub>CLK</sub>) are:HS (high-speed main) mode: 24 MHz (2.7 V ≤ V<sub>DD</sub> ≤ 5.5 V)16 MHz (2.4 V ≤ V<sub>DD</sub> ≤ 5.5 V)

**Caution** Select the TTL input buffer for the Rx<sub>Dq</sub> pin and the N-ch open drain output (V<sub>DD</sub> tolerance (32- to 52-pin products)/EV<sub>DD</sub> tolerance (64-pin products)) mode for the Tx<sub>Dq</sub> pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

**Remarks 1.** V<sub>b</sub>[V]: Communication line voltage**2.** q: UART number (q = 0), g: PIM and POM number (g = 1)**3.** f<sub>MCK</sub>: Serial array unit operation clock frequency

(Operation clock to be set by the serial clock select register m (SPSm) and the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00, 01))

(2) I<sup>2</sup>C fast mode(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ EV<sub>DD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS</sub> = 0 V)

Parameter	Symbol	Conditions		HS (high-speed main) Mode		Unit
				MIN.	MAX.	
SCLA0 clock frequency	f <sub>SCL</sub>	Fast mode: f <sub>CLK</sub> ≥ 3.5 MHz	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V	0	400	kHz
			2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V	0	400	
Setup time of restart condition	t <sub>SU:STA</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0.6		μs
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0.6		
Hold time <sup>Note 1</sup>	t <sub>HD:STA</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0.6		μs
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0.6		
Hold time when SCLA0 = “L”	t <sub>LOW</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V		1.3		μs
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V		1.3		
Hold time when SCLA0 = “H”	t <sub>HIGH</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0.6		μs
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0.6		
Data setup time (reception)	t <sub>SU:DAT</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V		100		ns
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V		100		
Data hold time (transmission) <sup>Note 2</sup>	t <sub>HD:DAT</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0	0.9	μs
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0	0.9	
Setup time of stop condition	t <sub>SU:STO</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0.6		μs
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V		0.6		
Bus-free time	t <sub>BUF</sub>	2.7 V ≤ EV <sub>DD</sub> ≤ 5.5 V		1.3		μs
		2.4 V ≤ EV <sub>DD</sub> ≤ 5.5 V		1.3		

- Notes**
1. The first clock pulse is generated after this period when the start/restart condition is detected.
  2. The maximum value (MAX.) of t<sub>HD:DAT</sub> is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

**Remark** The maximum value of C<sub>b</sub> (communication line capacitance) and the value of R<sub>b</sub> (communication line pull-up resistor) at that time in each mode are as follows.

Fast mode: C<sub>b</sub> = 320 pF, R<sub>b</sub> = 1.1 kΩ



(4) When reference voltage (+) = Internal reference voltage (ADREFP1 = 1, ADREFP0 = 0), reference voltage (-) = AV<sub>REFM</sub>/ANI1 (ADREFM = 1), target pin : ANI0, ANI16 to ANI23

(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ EV<sub>DD</sub> = V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS</sub> = 0 V, Reference voltage (+) = V<sub>BGR</sub><sup>Note 3</sup>, Reference voltage (-) = AV<sub>REFM</sub><sup>Note 4</sup> = 0 V, HS (high-speed main) mode)

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Resolution	RES			8			bit
Conversion time	t <sub>CONV</sub>	8-bit resolution	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V	17		39	μs
Zero-scale error <sup>Notes 1, 2</sup>	E <sub>zs</sub>	8-bit resolution	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V			±0.60	%FSR
Integral linearity error <sup>Note 1</sup>	ILE	8-bit resolution	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V			±2.0	LSB
Differential linearity error <sup>Note 1</sup>	DLE	8-bit resolution	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V			±1.0	LSB
Analog input voltage	V <sub>AIN</sub>			0		V <sub>BGR</sub> <sup>Note 3</sup>	V

**Notes** 1. Excludes quantization error (±1/2 LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. Refer to **3.6.2 Temperature sensor/internal reference voltage characteristics**.

4. When reference voltage (-) = V<sub>SS</sub>, the MAX. values are as follows.

Zero-scale error: Add ±0.35%FSR to the MAX. value when reference voltage (-) = AV<sub>REFM</sub>.

Integral linearity error: Add ±0.5 LSB to the MAX. value when reference voltage (-) = AV<sub>REFM</sub>.

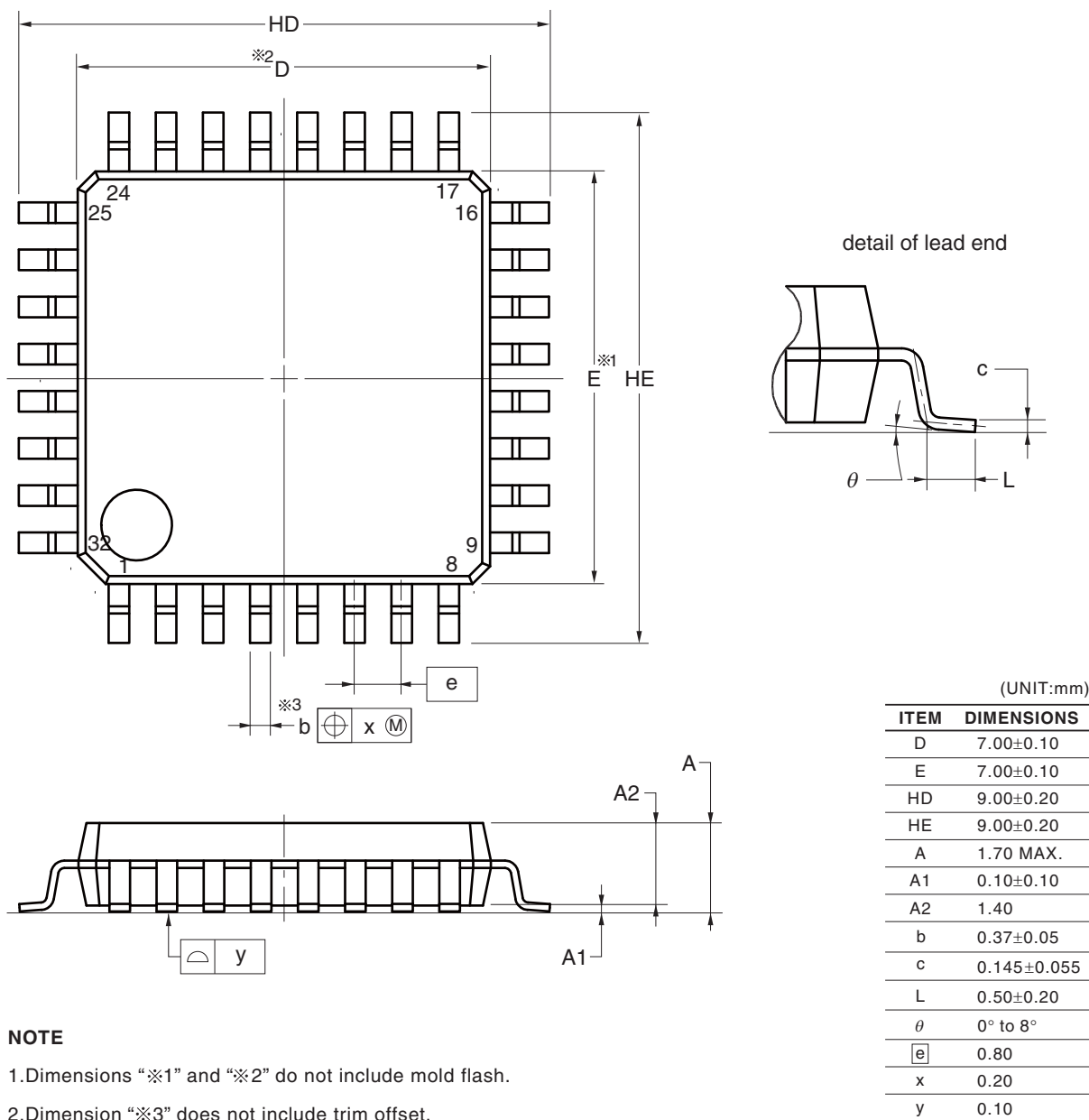
Differential linearity error: Add ±0.2 LSB to the MAX. value when reference voltage (-) = AV<sub>REFM</sub>.

## 4. PACKAGE DRAWINGS

### 4.1 32-pin Products

R5F10RB8AFP, R5F10RBAAFP, R5F10RBCAFP  
R5F10RB8GFP, R5F10RBAGFP, R5F10RBCGFP

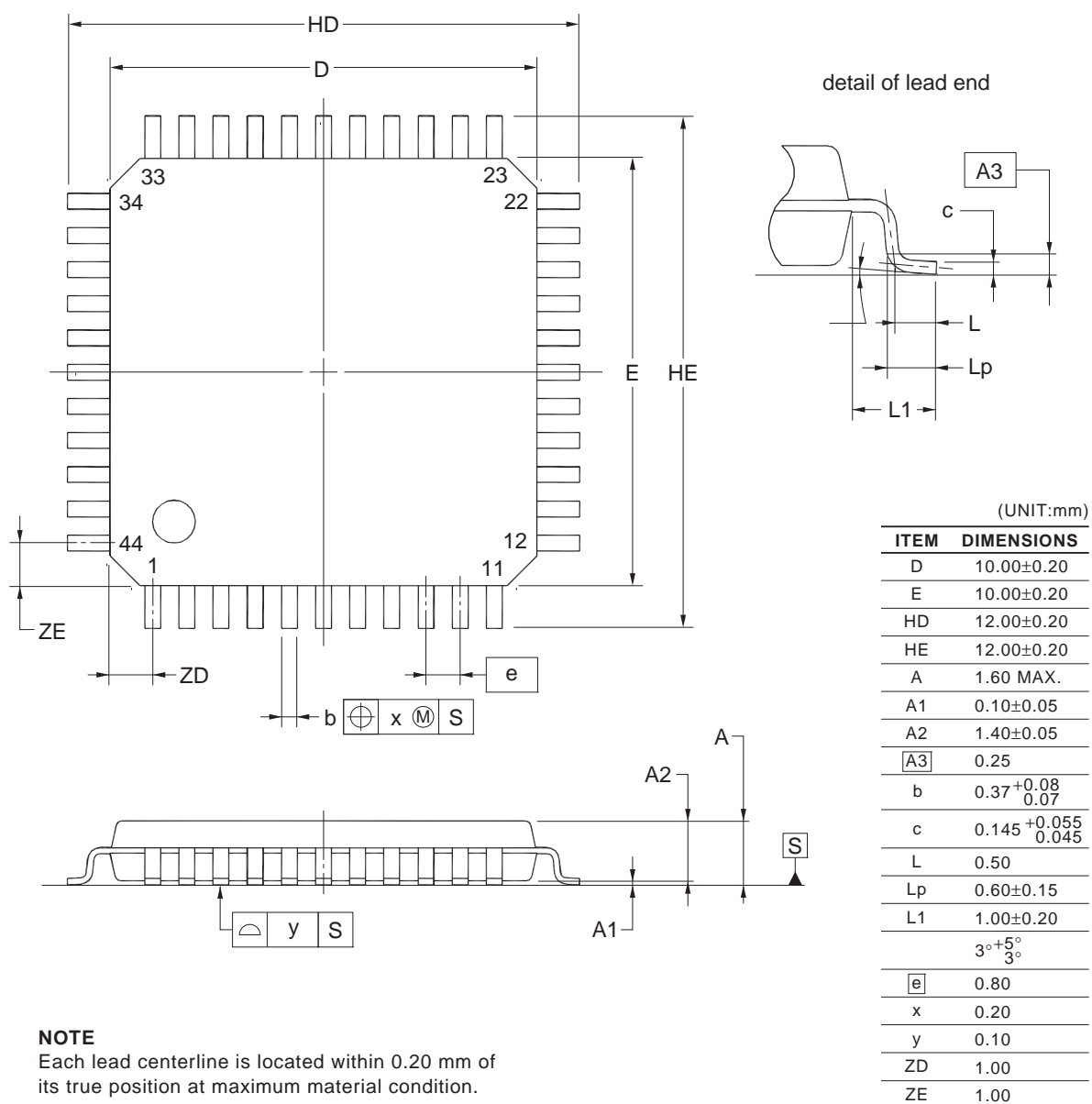
JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LQFP32-7x7-0.80	PLQP0032GB-A	P32GA-80-GBT-1	0.2



## 4.2 44-pin Products

R5F10RF8AFP, R5F10RFAAFP, R5F10RFCAFP  
 R5F10RF8GFP, R5F10RFAGFP, R5F10RFCGFP

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LQFP44-10x10-0.80	PLQP0044GC-A	P44GB-80-UES-2	0.36

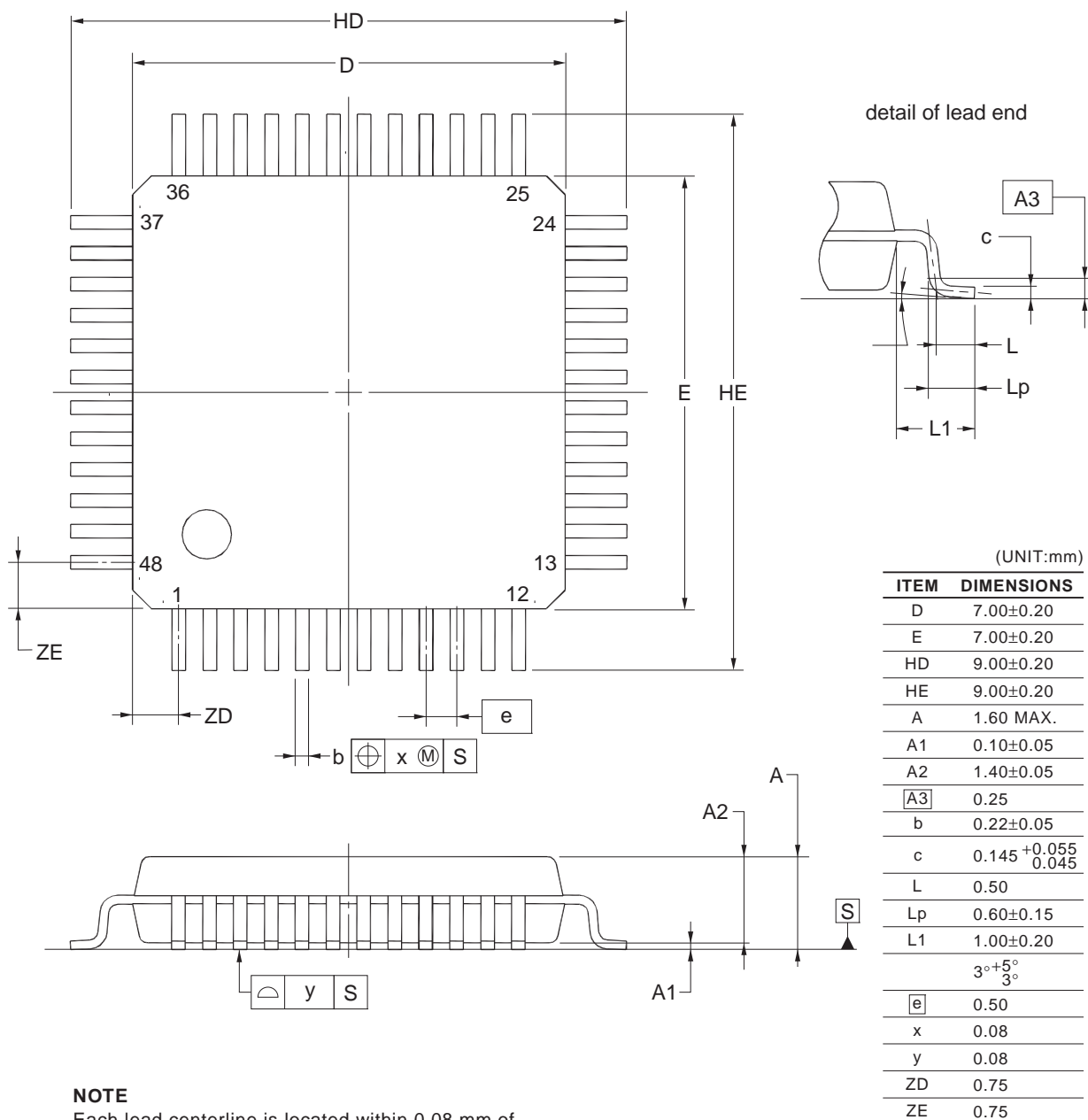


## 4.3 48-pin Products

R5F10RG8AFB, R5F10RGAAFB, R5F10RGCAFB

R5F10RG8GFB, R5F10RGAGFB, R5F10RGCGFB

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LFQFP48-7x7-0.50	PLQP0048KF-A	P48GA-50-8EU-1	0.16

**NOTE**

Each lead centerline is located within 0.08 mm of its true position at maximum material condition.

The mark “<R>” shows major revised points. The revised points can be easily searched by copying an “<R>” in the PDF file and specifying it in the “Find what:” field.

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